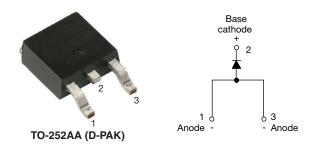
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# Surface Mount Fast Soft Recovery Rectifier Diode, 8 A



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PRODUCT SUMMARY							
Package	TO-252AA (D-PAK)						
I <sub>F(AV)</sub>	8 A						
V <sub>R</sub>	200 V, 400 V, 600 V						
V <sub>F</sub> at I <sub>F</sub>	1.2 V						
I <sub>FSM</sub>	150 A						
t <sub>rr</sub>	55 ns						
T <sub>J</sub> max.	150 °C						
Diode variation	Single die						
Snap factor	0.5						

### FEATURES

- Glass passivated pellet chip junction
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>
  Halogen FREE

### **APPLICATIONS**

- Output rectification and freewheeling diode in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

### DESCRIPTION

The VS-8EWF..S-M3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	CHARACTERISTICS	VALUES	UNITS					
I <sub>F(AV)</sub>	Sinusoidal waveform	8	A					
V <sub>RRM</sub>		200 to 600	V					
I <sub>FSM</sub>		150	А					
V <sub>F</sub>	8 A, T <sub>J</sub> = 25 °C	1.2	V					
t <sub>rr</sub>	1 A, 100 A/µs	55	ns					
TJ	Range	-40 to +150	٦°					

VOLTAGE RATINGS								
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> AT 150 °C mA					
VS-8EWF02S-M3	200	300						
VS-8EWF04S-M3	400	500	3					
VS-8EWF06S-M3	600	700						

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL TEST CONDITIONS		VALUES	UNITS				
Maximum average forward current	I <sub>F(AV)</sub>	$T_C = 96 ^{\circ}C$ , 180° conduction half sine wave	8					
Maximum peak one cycle	I <sub>FSM</sub>	10 ms sine pulse, rated V <sub>RRM</sub> applied 125		А				
non-repetitive surge current		10 ms sine pulse, no voltage reapplied	150					
Maximum I <sup>2</sup> t for fusing	l <sup>2</sup> t	10 ms sine pulse, rated V <sub>RRM</sub> applied	78	A <sup>2</sup> s				
Maximum 12t for fusing		10 ms sine pulse, no voltage reapplied	110	A-2				
Maximum I <sup>2</sup> $\sqrt{t}$ for fusing	l²√t	t = 0.1 ms to 10 ms, no voltage reapplied	1100	A²√s				

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ELECTRICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS					
Maximum forward voltage drop	V <sub>FM</sub>	8 A, T <sub>J</sub> = 25 °C	1.2	V					
Forward slope resistance	r <sub>t</sub>	T.ı = 150 °C	16	mΩ					
Threshold voltage	V <sub>F(TO)</sub>	1j = 150 C	1.13	V					
		T <sub>J</sub> = 25 °C	V - Roted V	0.1	mA				
Maximum reverse leakage current	IRM	T <sub>J</sub> = 150 °C	V <sub>R</sub> = Rated V <sub>RRM</sub>	3	IIIA				

RECOVERY CHARACTERISTICS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Reverse recovery time	t <sub>rr</sub>	l <sub>F</sub> at 1 A <sub>pk</sub> 100 A/µs T <sub>J</sub> = 25 °C	55	ns			
		I <sub>F</sub> at 8 A <sub>pk</sub>	200				
Reverse recovery current	I <sub>rr</sub>	25 A/µs	2.6	А			
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	0.25	μC			
Snap factor	S		0.5				

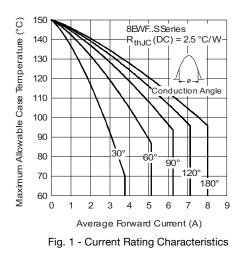
THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C				
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	2.5	°C/W				
Typical thermal resistance, junction to ambient (PCB mount)	R <sub>thJA</sub> <sup>(1)</sup>		50	0/11				
Approximate weight			1	g				
Approximate weight			0.03	oz.				
			8EWF02S					
Marking device		Case style TO-252AA (D-PAK)	8EWF04S					
			8EWF06S					

Note

(1) When mounted on 1" square (650 mm<sup>2</sup>) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994



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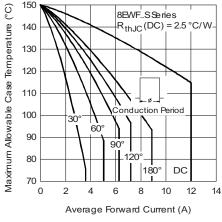
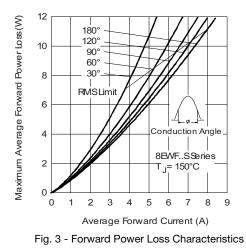


Fig. 2 - Current Rating Characteristics



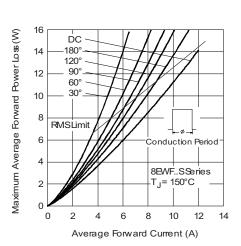


Fig. 4 - Forward Power Loss Characteristics

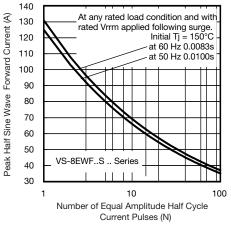


Fig. 5 - Maximum Non-Repetitive Surge Current

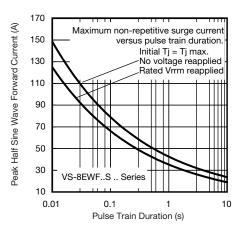


Fig. 6 - Maximum Non-Repetitive Surge Current

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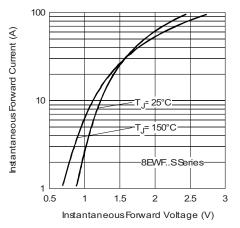


Fig. 7 - Forward Voltage Drop Characteristics

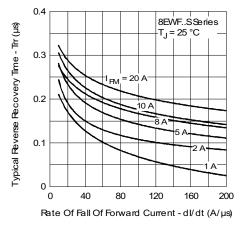


Fig. 8 - Recovery Time Characteristics, T<sub>J</sub> = 25 °C

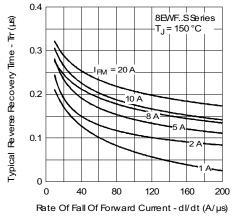


Fig. 9 - Recovery Time Characteristics,  $T_J$  = 150  $^\circ C$ 

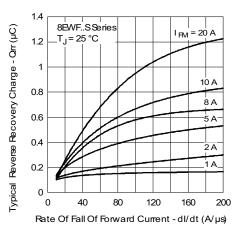


Fig. 10 - Recovery Charge Characteristics,  $T_J = 25 \ ^{\circ}C$ 

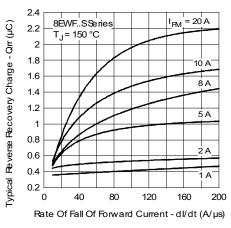


Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C

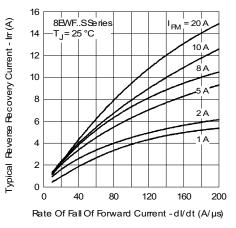


Fig. 12 - Recovery Current Characteristics,  $T_J = 25$  °C

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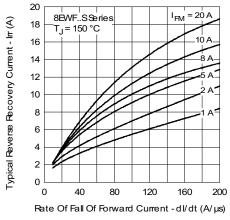


Fig. 13 - Recovery Current Characteristics,  $T_J = 150 \ ^\circ C$ 

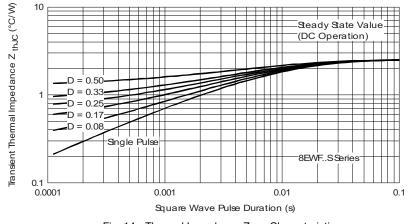


Fig. 14 - Thermal Impedance ZthJC Characteristics

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### **ORDERING INFORMATION TABLE**

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Device code	VS-	8	Е	w	F	06	S	TR	-M3		
		2	3	4	5	6	(7)	8	9		
	1 - 2 -			niconduo		oduct					
	3 - Circuit configuration:										
	4	- Pac	E = single diode Package:								
	5 -	• Тур	D-PAK	con:							
	6		F = fast soft recovery rectifier Voltage code x 100 = $V_{RRM}$ 02 = 200 V 04 = 400 V								
	7 - 8 -		S = surface mountable 06 = 600 V • TR = tape and reel								
		• TI	• TRR = tape and reel (right oriented)								
	9 -			be and re ntal digit		oriente	d)				

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-8EWF02S-M3	75	3000	Antistatic plastic tubes						
VS-8EWF02STR-M3	2000	2000	13" diameter reel						
VS-8EWF02STRL-M3	3000	3000	13" diameter reel						
VS-8EWF02STRR-M3	3000	3000	13" diameter reel						
VS-8EWF04S-M3	75	3000	Antistatic plastic tubes						
VS-8EWF04STR-M3	2000	2000	13" diameter reel						
VS-8EWF04STRL-M3	3000	3000	13" diameter reel						
VS-8EWF04STRR-M3	3000	3000	13" diameter reel						
VS-8EWF06S-M3	75	3000	Antistatic plastic tubes						
VS-8EWF06STR-M3	2000	2000	13" diameter reel						
VS-8EWF06STRL-M3	3000	3000	13" diameter reel						
VS-8EWF06STRR-M3	3000	3000	13" diameter reel						

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95627						
Part marking information	www.vishay.com/doc?95176						
Packaging information	www.vishay.com/doc?95033						
SPICE model	www.vishay.com/doc?95551						

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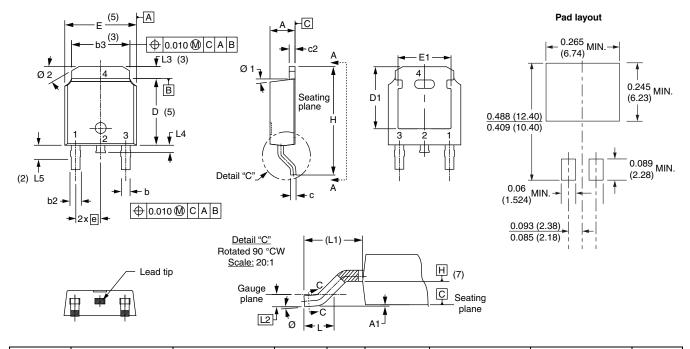
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D-PAK (TO-252AA) "M"

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	2.18	2.39	0.086	0.094			е	2.29	BSC	0.090	BSC	
A1	-	0.13	-	0.005			Н	9.40	10.41	0.370	0.410	
b	0.64	0.89	0.025	0.035			L	1.40	1.78	0.055	0.070	
b2	0.76	1.14	0.030	0.045			L1	2.74	BSC	0.108	REF.	
b3	4.95	5.46	0.195	0.215	3		L2	0.51 BSC		0.020 BSC		
С	0.46	0.61	0.018	0.024			L3	0.89	1.27	0.035	0.050	3
c2	0.46	0.89	0.018	0.035			L4	-	1.02	-	0.040	
D	5.97	6.22	0.235	0.245	5		L5	1.14	1.52	0.045	0.060	2
D1	5.21	-	0.205	-	3		Ø	0°	10°	0°	10°	
E	6.35	6.73	0.250	0.265	5		Ø1	0°	15°	0°	15°	
E1	4.32	-	0.170	-	3		Ø2	25°	35°	25°	35°	

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994

<sup>(2)</sup> Lead dimension uncontrolled in L5

<sup>(3)</sup> Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

(4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip

(5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(6)</sup> Dimension b1 and c1 applied to base metal only

<sup>(7)</sup> Datum A and B to be determined at datum plane H

<sup>(8)</sup> Outline conforms to JEDEC<sup>®</sup> outline TO-252AA

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